



CR200F-10-02

200mm Wafer Carrier

Pozzetta will protect your valuable products from particles, ESD damage, outgassed components, and high costs. Companies around the world trust Pozzetta to create secure environments for the semiconductor, electronics, and medical industries.

Dimensions

Capacity: 13

Overall Size: 235mm (9.25in) x
210mm (8.26in) x 219mm (8.62in)

D₁ Dimension – distance from the H-shaped end surface to the center line of the first pocket: 28.58mm (1.13in)

Pocket Spacing – The distance between pocket center lines:
12.7mm (0.5in)

Pocket Flat – The width of the pocket at its narrowest distance: 8.75mm (0.34in)

Features and Benefits

- H-shaped end for equipment interface
- Solid end wall
- Solid side walls

Material Description

- Peek+CF (a conductive high-performance resin) has excellent heat resistance and rigidity. It is ideal for use in high temperature applications, such as wafer baking, diffusion and CVD.

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